

SSC8L42PN6

N-Channel Enhanced MOSFET

> Features

VDS	VGS	RDSON Typ.	ID
40)/	1201/	1.0mR@10V	1504
40V	±20V	1.5mR@4V5	150A

> Description

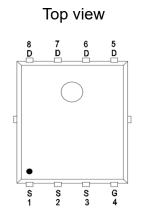
This device is N-Channel enhancement MOSFET. Uses SGT technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit.

- > Applications
- DC/DC converters
- Power supplies
- Motor Drive Control
- Synchronous rectification

> Ordering Information

Device	Package	Shipping
SSC8L42PN6	PDFN5X6	5000/Reel

Pin configuration





PDFN5X6



Marking

(XX: product year / YY: product week)

> Absolute Maximum Ratings(T_A=25°C unless otherwise noted)

Symbol	Parameter		Ratings	Unit
V _{DSS}	Drain-to-Source Vol	tage	40	V
V _{GSS}	Gate-to-Source Volt	tage	±20	V
	Continuous Drain Current ^d	Tc=25℃	150	
lo		Tc=100°C	95	A
	Continuous Drain Current ^a	T _A =25℃	46	
IDSM		T _A =70°C	34	A
I _{DM}	Pulsed Drain Curre	500	А	
_	Power Dissipation ^c	Tc=25℃	78	14/
PD		Tc=100℃	32	W
P	Power Dissipation ^a	T _A =25℃	7.0	14/
Pdsm		T _A =70℃	4.5	W
las	Avalanche Current ^b L=0.5ml	42	А	
Eas	Avalanche Energy ^b L=0.5m	H Single Pulse	441	mJ
TJ	Operation junction temperature		-55~150	°C
Tstg	Storage temperature	-55~150	°C	

> Thermal Resistance Ratings($T_A=25^{\circ}$ unless otherwise noted)

Symbol	Parameter	Ratings	Unit
R _{θJA}	Junction-to-Ambient Thermal Resistance ^a	17	°C/W
R _{θJC}	Junction-to-Case Thermal Resistance	1.5	C/ VV

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25°C.The value in any given application depends on the user is specific board design. The power dissipation is based on the t ≤ 10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

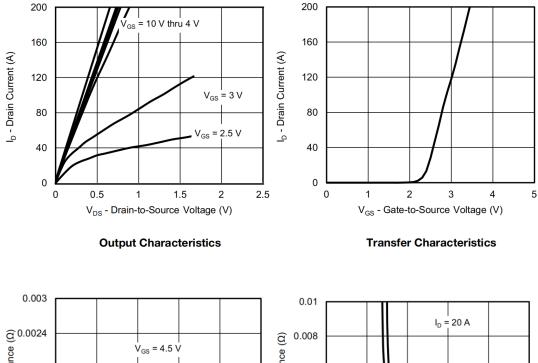


Electronics Characteristics(T_A=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Unit
V _{(BR)DSS}	Drain-Source Breakdown Voltage	VGS=0V, ID=250uA	40			V
$V_{GS \ (th)}$	Gate Threshold Voltage	VDS=VGS, ID=250uA	1.4	1.9	2.4	V
D	Drain-Source On-	VGS=10V , ID=50A		1.0	1.24	D
$R_{DS(on)}$	Resistance	VGS=4.5V , ID=50A		1.5	2.1	mR
I _{DSS}	Zero Gate Voltage Drain Current	VDS=40V, VGS=0V			1.0	uA
I _{GSS}	Gate-Source leak current	VGS=±20V, VDS=0V			±100	nA
G _{FS}	Transconductance	VDS=5V, ID=20A		110		S
V _{SD}	Forward Voltage	VGS=0V, IS=20A			1.3	V
Rg	Gate Resistance	VDS=0V, f=1MHz		2.3		R
Ciss	Input Capacitance			5900		
Coss	Output Capacitance	VDS=20V, VGS=0V,		2100		pF
Crss	Reverse Capacitance	f=1MHz		112		
T _{D(ON)}	Turn-on delay time			23		
Tr	Rise time	VGS=10V, RL=0.4R		64		
Td(off)	Turn-off delay time	VDS=20V , RG=4.7R		88		ns
Tf	Fall time			30		
QG	Total Gate Charge			86		
Q _{GS}	Gate Source Charge	VGS=10V, VDS=20V		27		nC
Q _{GD}	Gate Drain Charge	ID=50A		9		
Trr	Diode Recovery Time	IF=37A , di/dt=100A/us		65		ns
Qrr	Diode Recovery Charge	IF=37A , di/dt=100A/us		72		nC



> Typical Characteristics(T_A=25°C unless otherwise noted)



0.006

0.004

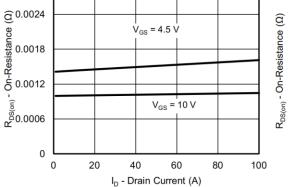
0.002

0

0

 $T_J = 25 °C$

2



On-Resistance vs. Drain Current



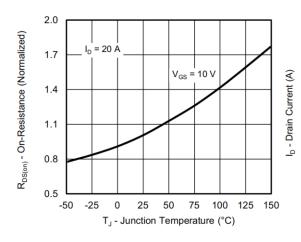
6

4

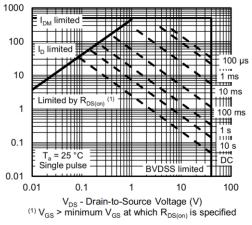
T_J = 125 °C

8

10



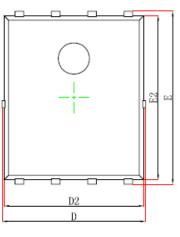
On-Resistance vs. Junction Temperature



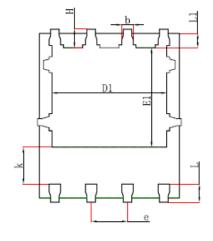




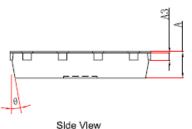
Package Information







<u>Bottom Vlew</u> [背视图]



<u>Slde Vlew</u> [側视图]

Symbol	Dimensions	In Millimeters	Dimension	is In Inches
	Min.	Max.	Min.	Max.
А	0.900	1.000	0.035	0.039
A3	0.254	4REF	0.01	OREF
D	4.944	5.096	0.195	0.201
E	5.974	6.126	0.235	0.241
D1	3.910	4.110	0.154	0.162
E1	3.375	3.575	0.133	0.141
D2	4.824	4.976	0.190	0.196
E2	5.674	5.826	0.223	0.229
k	1.190	1.390	0.047	0.055
b	0.350	0.450	0.014	0.018
е	1.27	1.270TYP		OTYP
L	0.559	0.711	0.022	0.028
L1	0.424	0.576	0.017	0.023
Н	0.574	0.726	0.023	0.029
θ	10°	12°	10°	12°



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